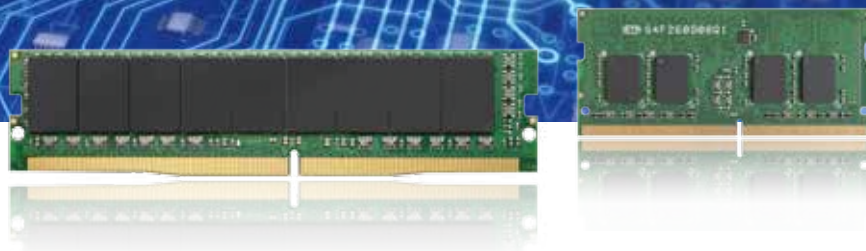**ATP**

ATP Electronics, Inc.

ATP DDR4-2666 modules

for Intel® Xeon® Scalable and 8th-generation Intel® Core™ Processors

Rev Up Your Enterprise

Blaze through massive memory workloads while generating big power savings with ATP DDR4-2666 modules built for the latest Intel® Xeon® Platinum, Gold, Silver and Bronze Scalable processors and 8th-generation Intel® Core™ i7/i5/i3 processors. Designed to meet growing and evolving enterprise demands, ATP DDR4 solutions can expand operational capabilities, cut down TCO, and ensure that your organizations are ready for the future.

High-performance computing (HPC) applications such as telecommunication infrastructure, networking storage systems, NAS (Network Attached Storage), micro/cloud servers, and embedded systems like industrial PCs will greatly benefit from:

■ Accelerated Performance

Enterprise-level density meets large-scale, memory-intensive workloads. The fast 2666 MT/s data rate delivers speedy performance for greater productivity.

■ Immense Power Savings

A mere 1.2V power consumption keeps systems cool and energy costs at a minimum, translating to better efficiency and big savings.

■ Future-Ready Scalability

The 8 Gbit IC design enables cost-effective expansion of memory footprints to keep pace with future requirements.

Product Family

Type	Data Rate	Voltage	PCB Height	Operating Temperature	Golden Finger	Density
RDIMM	2666 MT/s	1.2V	STD 31.25 mm	0-85°C	30μ	4 GB / 8 GB / 16 GB / 32 GB
ECC UDIMM	2666 MT/s	1.2V	STD 31.25 mm	0-85°C	30μ	4 GB / 8 GB / 16 GB
ECC SODIMM	2666 MT/s	1.2V	STD 30 mm	0-85°C	30μ	4 GB / 8 GB / 16 GB
UDIMM	2666 MT/s	1.2V	STD 31.25 mm	0-85°C	30μ	4 GB / 8 GB / 16 GB
SODIMM	2666 MT/s	1.2V	STD 30 mm	0-85°C	30μ	4 GB / 8 GB / 16 GB

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